Product Preview **Power MOSFET 6 Amps, 30 Volts**

N–Channel SO–8, FETKY™

The FETKY product family incorporates low RDS(on), true logic level MOSFETs packaged with industry leading, low forward drop, low leakage Schottky Barrier rectifiers to offer high efficiency components in a space saving configuration. Independent pinouts for MOSFET and Schottky die allow the flexibility to use a single component for switching and rectification functions in a wide variety of applications such as Buck Converter, Buck–Boost, Synchronous Rectification, Low Voltage Motor Control, and Load Management in Battery Packs, Chargers, Cell Phones and other Portable Products.

- Power MOSFET with Low VF
- Lower Component Placement and Inventory Costs along with Board Space Savings
- Logic Level Gate Drive Can be Driven by Logic ICs
- Mounting Information for SO-8 Package Provided
- Applications Information Provided
- R2 Suffix for Tape and Reel (2500 units/13" reel)
- Marking: 6N303

MOSFET MAXIMUM RATINGS (T_J = 25° C unless otherwise noted) (Note 1.)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	VDSS	30	Vdc
Drain–to–Gate Voltage (R_{GS} = 1.0 M Ω)	VDGR	30	Vdc
Gate-to-Source Voltage — Continuous	VGS	±20	Vdc
Drain Current (Note 2.) Continuous @ T _A = 25°C Single Pulse (tp ≤ 10 μs)	I _D IDM	6.0 30	Adc Apk
Total Power Dissipation @ T _A = 25°C (Note 2.)	PD	2.0	Watts
$ Single Pulse Drain-to-Source Avalanche \\ Energy — STARTING T_J = 25^\circ C \\ V_{DD} = 30 \ Vdc, \ V_{GS} = 5.0 \ Vdc, \ V_{DS} = 20 \\ Vdc, \ I_L = 9.0 \ Apk, \ L = 10 \ mH, \ R_G = 25 \ \Omega $	EAS	325	mJ

1. Pulse Test: Pulse Width \leq 250 µs, Duty Cycle \leq 2.0%.

 Mounted on 2" square FR4 board (1" sq. 2 oz. Cu 0.06" thick single sided), 10 sec. max.



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6 AMPERES 30 VOLTS RDS(on) = 35 mΩ VF = 0.42 Volts







PIN ASSIGNMENT



ORDERING INFORMATION

Device	Package	Shipping
MMDFS6N303R2	SO–8	2500 Tape & Reel

This document contains information on a product under development. ON Semiconductor reserves the right to change or discontinue this product without notice.

SCHOTTKY RECTIFIER MAXIMUM RATINGS (T_J = 25° C unless otherwise noted)

Peak Repetitive Reverse Voltage DC Blocking Voltage	V _{RRM} V _R	30	Volts
Average Forward Current (Note 2.) (Rated V _R) T _A = 104°C	lO	2.0	Amps
Peak Repetitive Forward Current (Note 2.) (Rated V_R , Square Wave, 20 kHz) T_A = 108°C	lfrm	4.0	Amps
Non–Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	l _{fsm}	30	Amps

THERMAL CHARACTERISTICS — SCHOTTKY AND MOSFET

Thermal Resistance — Junction-to-Ambient (Note 3.) — MOSFET	$R_{\theta JA}$	167	°C/W
Thermal Resistance — Junction-to-Ambient (Note 4.) — MOSFET	$R_{\theta JA}$	97	
Thermal Resistance — Junction-to-Ambient (Note 2.) — MOSFET	$R_{\theta JA}$	62.5	
Thermal Resistance — Junction-to-Ambient (Note 3.) — Schottky	$R_{\theta JA}$	197	
Thermal Resistance — Junction-to-Ambient (Note 4.) — Schottky	$R_{\theta JA}$	97	
Thermal Resistance — Junction-to-Ambient (Note 2.) — Schottky	$R_{\theta JA}$	62.5	
Operating and Storage Temperature Range	Tj, Tstg	-55 to 150	

2. Mounted on 2" square FR4 board (1" sq. 2 oz. Cu 0.06" thick single sided), 10 sec. max.

3. Mounted with minimum recommended pad size, PC Board FR4.

4. Mounted on 2" square FR4 board (1" sq. 2 oz. Cu 0.06" thick single sided), Steady State.

MOSFET ELECTRICAL CHARACTERISTICS ($T_C = 25^{\circ}C$ unless otherwise noted) (Note 5.)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
Drain–Source Voltage (V _{GS} = 0 Vdc, I _D = 0.25 mA) Temperature Coefficient (Positive)	V(BR)DSS	30 —			Vdc mV/°C
Zero Gate Drain Current $(V_{DS} = 24 \text{ Vdc}, V_{GS} = 0 \text{ Vdc})$ $(V_{DS} = 24 \text{ Vdc}, V_{GS} = 0 \text{ Vdc}, T_J = 125^{\circ}\text{C})$	IDSS		_	1.0 20	μAdc
Gate Body Leakage Current (V _{GS} = \pm 20 Vdc, V _D	s = 0) I _{GSS}	—	—	100	nAdc
ON CHARACTERISTICS (Note 5.)					
Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 0.25 mA) Temperature Coefficient (Negative)	V _{GS(th)}	1.0			Vdc
Static Drain–Source Resistance (V_{GS} = 10 Vdc, I_D = 5.0 Adc) (V_{GS} = 4.5 Vdc, I_D = 3.9 Adc)	R _{DS(on)}		28 42	35 50	mΩ
Forward Transconductance (V_{DS} = 15 Vdc, I_D = 5	.0 Adc) gFS	—	9.0	-	mhos
DYNAMIC CHARACTERISTICS					•
Input Capacitance	C _{iss}	—	430	600	pF

Input Capacitance		Ciss	_	430	600	р⊢
Output Capacitance	(V _{DS} = 24 Vdc, V _{GS} = 0 Vdc, f = 1.0 MHz)	C _{OSS}		217	300	
Reverse Transfer Capacitance	,	C _{rss}		67.5	135	

5. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

MOSFET ELECTRICA	_ CHARACTERISTICS	S – continued (⊺ _C	= 25°C unless otherwise	noted) (Note 5.)
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Characteristic		Symbol	Min	Тур	Max	Unit
SWITCHING CHARACTERISTICS	(Note 6.)					
Turn–On Delay Time		^t d(on)	—	8.2	16.5	ns
Rise Time	$(V_{DD} = 15 \text{ Vdc}, I_{D} = 1.0 \text{ Adc},$	t _r	—	8.5	17	
Turn–Off Delay Time	$R_{G} = 6.0 \Omega$	^t d(off)	—	89.6	179	
Fall Time		t _f	—	61.1	122	
Gate Charge		QT	—	15.7	31.4	nC
	(V _{DS} = 15 Vdc, I _D = 5.0 Adc,	Q ₁	—	2.0	—	
VGs	V _{GS} = 10 Vdc)	Q ₂	—	4.6	—	
		Q ₃	—	3.9	—	

DRAIN SOURCE DIODE CHARACTERISTICS

Forward On–Voltage (Note 5.)	(I _S = 1.7 Adc, V _{GS} = 0 Vdc)	V _{SD}	_	0.77	1.2	Vdc
Reverse Recovery Time		t _{rr}	_	54.5	—	ns
		^t a	—	14.8	—	
	dlS/dt = 100 A/μs)	tb	—	39.7	—	
Reverse Recovery Stored Charge		Q _{RR}	—	0.048	—	μC

SCHOTTKY RECTIFIER ELECTRICAL CHARACTERISTICS (T_C = 25°C unless otherwise noted)

Maximum Instantaneous Forward Voltage (Note 5.)	٧F	T _J = 25°C	T _J = 125°C	Volts
I _F = 100 mAdc I _F = 3.0 Adc I _F = 6.0 Adc		0.28 0.42 0.50	0.13 0.33 0.45	
Maximum Instantaneous Reverse Current (Note 5.)	IR	Tj = 25°C	Tj = 125°C	μΑ
V _R = 30 V		250	—	
		—	25	mA
Maximum Voltage Rate of Change $V_R = 30 V$	dV/dt	10,000		V/μs

5. Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.
6. Switching characteristics are independent of operating junction temperature.

TYPICAL FET ELECTRICAL CHARACTERISTICS



TYPICAL FET ELECTRICAL CHARACTERISTICS







TYPICAL FET ELECTRICAL CHARACTERISTICS











TYPICAL SCHOTTKY ELECTRICAL CHARACTERISTICS











TYPICAL SCHOTTKY ELECTRICAL CHARACTERISTICS



Figure 22. Schottky Thermal Response

TYPICAL APPLICATIONS

STEP DOWN SWITCHING REGULATORS





TYPICAL APPLICATIONS

STEP UP SWITCHING REGULATORS



Buck–Boost Regulator

MULTIPLE BATTERY CHARGERS



TYPICAL APPLICATIONS

Li-Ion BATTERY PACK APPLICATIONS



- Applicable in battery packs which require a high current level.
- During charge cycle Q2 is on and Q1 is off. Schottky can reduce power loss during fast charge.
- During discharge Q1 is on and Q2 is off. Again, Schottky can reduce power dissipation.
- Under normal operation, both transistors are on.



SO-8 FOOTPRINT

PACKAGE DIMENSIONS

SO-8 CASE 751-07 ISSUE V



NOTES:
DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: MILLIMETER.
DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR
PROTRUSION. ALLOWABLE DAMBAR
PROTRUSION. ALLOWABLE DAMBAR
PROTRUSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	4.80	5.00	0.189	0.197
В	3.80	4.00	0.150	0.157
C	1.35	1.75	0.053	0.069
D	0.33	0.51	0.013	0.020
G	1.2	7 BSC	0.050 BSC	
Н	0.10	0.25	0.004	0.010
J	0.19	0.25	0.007	0.010
K	0.40	1.27	0.016	0.050
М	0 °	8 °	0 °	8 °
N	0.25	0.50	0.010	0.020
S	5.80	6.20	0.228	0 244

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STYLE 18: PIN 1. ANODE 2. ANODE 3. SOURCE

4. GATE

GATE
DRAIN
DRAIN
DRAIN
CATHODE
CATHODE

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